

# **Nuisance Processes in p-on-n SiPMs**

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### Introduction to SiPMs

Main Characteristics:

- SPADs connected in parallel
- Operated in reverse bias mode
- Incoming photon triggers charge avalanche
- Single pixel is discharged

#### Advantages:

- High gain at low bias voltage
- Single photon detection resolution
- High radio purity possible
- Suitable at cryogenic temperature



Voltage [mV]





#### **Noise Sources in SiPMs**

#### **Uncorrelated Avalanche Noise**

- Dark Noise (DN)

#### **Correlated Avalanche Noise (CA)**

- Afterpulse (AP)
- Cross talk (CT)

This talk will focus on SiPM Dark Noise and CA noise modellization

- Explain voltage and temperature dependence  $\bullet$ of nuisance processes in Geiger mode devices
- In literature several models for avalanche photodiodes are available but literature is limited for Geiger mode devices



**Fig. 7.** Primary pulses (PP) with different types of correlated pulses such as prompt CT (CT-P), afterpulse (AP) and delayed CT (CT-D).







# Modellization of the SiPM Dark Noise Rate



# How Do SiPMs work?

p-n junctions micro-cells operated in Geigermode, with an added quenching resistor. Each SiPM is composed by multiple microcells.







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## How Do SiPMs work?

An incoming photon enters the junction and it is absorbed (wavelength dependent process :  $\lambda$ ).



 $\lambda_1 > \lambda_2$ 







# **How Do SiPMs work ?**

The internal field of the junction brings the generated carrier (e/h) to the avalanche/ region.



photon is absorbed



$$\mathbf{PDE}_{\lambda} = \mathbf{PDE}_{\mathbf{MAX}} \cdot \left( \mathbf{P}_{e}(d_{P}) \cdot f_{e}^{*} + \mathbf{P}_{h}(d_{W}) \cdot (1 - f_{e}^{*}) \right)$$

EDA: Electron Drive Avalanches ==  $f_{\rho}^{*}$ 



#### **Dark Noise Rate** $P_e(d_P)$ , $P_h(d_W)$ are the same probabilities derived in iEEE TED 66.10 (2019)

The Total Dark Noise Rate can be treated as a sum of electron and hole driven avalanches.

The difference is in the source: 1) <u>Thermal (only)</u> 2) Thermal - field enhanced

$$R_{DN} = \left\{ c_{srh} P_e(d_P) \left[ \left( f_{DN}(W - W_0) \right) + \frac{\sqrt{3\pi} W F_{\Gamma}}{2 |F_m|} \left[ \exp\left(\frac{F_m}{F_{\Gamma}}\right)^2 - \exp\left(\frac{F_m}{F_{\Gamma}}\right) \right] \right] + \frac{\sqrt{3\pi} W F_{\Gamma}}{2 |F_m|} \left[ \exp\left(\frac{F_m}{F_{\Gamma}}\right)^2 - \exp\left(\frac{F_m}{F_{\Gamma}}\left(1 - \frac{2}{W}(1 - f_{DN})(W - W_0)\right)^2\right] \right] \right\}$$

**Electron Driven Avalanches** 

**Hole Driven Avalanches** 

Shockley-Read-Hall rate  $c_{srh}$ 

 $-\frac{2}{W}f_{DN}(W-W_0)\Big)\Big)^2\Big]\Big|+$ 

This equation was derived with a symmetric junction approximation. We worked also on an extension for asymmetric junctions



#### **Dark Noise Rate** $P_{e}(d_{P}), P_{h}(d_{W})$ are the same probabilities derived in iEEE TED 66.10 (2019)



#### **Thermal Contribution** -> **Negligible**

**Thermal Field Enhanced Contribution Dominant Contribution** 

Shockley-Read-Hall rate C<sub>srh</sub>

$$\frac{1}{\Gamma} \left[ \exp\left(\frac{F_m}{F_{\Gamma}}\right)^2 - \exp\left(\frac{F_m}{F_{\Gamma}}\left(1 - \frac{2}{W}f_{DN}(W - W_0)\right)\right)^2 \right] + \frac{1}{2} \left[ \exp\left(\frac{F_m}{F_{\Gamma}}\left(1 - \frac{2}{W}f_{DN}(W - W_0)\right)\right)^2 \right] \right] + \frac{1}{2} \left[ \exp\left(\frac{F_m}{F_{\Gamma}}\right)^2 - \exp\left(\frac{F_m}{F_{\Gamma}}\left(1 - \frac{2}{W}f_{DN}(W - W_0)\right)\right)^2 \right] \right]$$

$$\left(1-f_{DN}\right)(W-W_0)\right)^2\right]$$

Fitting Parameters:

C<sub>srh</sub> Shockley-Read-Hall rate

Fraction of Noise Avalanche J<sub>DN</sub> Driven by Electron

Junction at Zero Bias

 $c_{srh}$  has a precise temperature dependence

 $W_0$ 







### Hamamatsu VUV4



 $f_{DN} \sim 0$  —> In p-on-n SiPMs DN is hole driven.

The Shockley-Read-Hall thermal rate has a slope that is **compatible with the Silicon Bandgap** 

The Dark Noise rate is **dominated by field enhanced contribution** 



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# Nuisance Processes: Cross Talk



#### **Direct Cross Talk**



#### Hamamatsu VUV4 Prompt Charge

# **Direct (or Prompt) Cross Talk**

$$N_{\text{APA}} = \chi \times k \times \frac{C(V - V_b)}{q_e}$$

The number of photons produced is proportional (k) to the charge realised during an avalanche

$$N_{ph-produced} \sim k \times \frac{C \times (V - V_{BD})}{q_e}$$

Geometrical factor to account for the cell geometry

 $f_{CT} \sim 0$ **Direct Cross Talk is Hole Driven** 

![](_page_15_Picture_6.jpeg)

 $\frac{bd}{d} \left( P_e(d_P) f_{CT} + P_h(d_W) (1 - f_{CT}) \right)$ 

![](_page_15_Figure_8.jpeg)

![](_page_15_Figure_10.jpeg)

# Nuisance Processes: Afterpulse

![](_page_16_Picture_1.jpeg)

![](_page_17_Picture_0.jpeg)

Two information can be extrapolated from the time differences: Dark Noise Rate and Number of Correlated Delayed Avalanches

![](_page_17_Figure_2.jpeg)

![](_page_17_Figure_3.jpeg)

![](_page_17_Picture_4.jpeg)

![](_page_17_Picture_5.jpeg)

#### **Neglecting the PE charges**

![](_page_18_Picture_0.jpeg)

Two information can be extrapolated from the time differences: Dark Noise Rate and Number of Correlated Delayed Avalanches

![](_page_18_Figure_2.jpeg)

![](_page_18_Figure_3.jpeg)

![](_page_18_Picture_4.jpeg)

![](_page_18_Picture_5.jpeg)

#### **Neglecting the PE charges**

![](_page_18_Figure_7.jpeg)

#### **After Pulse**

The number of carriers trapped is proportional (k) to the charge realised during an avalanche

$$N_{ph-produced} \sim \frac{C \times (V - V_{BD})}{q_e}$$

The trapping probability is proportional to the trap density

ASiPM $k_1$ NtrapsW

Detrapping probability:  $e^{-\overline{\tau}}$ 

 $N_{CDA}(t) = \frac{C(V - V_{BD})}{\sigma} \times A_{SiPM} k_1 N_{traps} W \times \frac{e^{-\overline{\tau}}}{\tau} \times A_{SiPM} k_1 N_{traps} K_1 N_{t$ 

 $\times \left[ f_{CDA} P_{e}(d_{P}, V - V_{eff}(t)) + (1 - f_{CDA}) P_{h}(d_{W}, V - V_{eff}(t)) \right]$ 

![](_page_19_Figure_10.jpeg)

 $f_{CDA} \sim 0$  After Pulse is Hole Driven

![](_page_19_Figure_12.jpeg)

![](_page_19_Figure_13.jpeg)

# Nuisance Processes: Summary

![](_page_20_Picture_1.jpeg)

2	1

![](_page_21_Picture_0.jpeg)

#### **Dark Noise**

 $f_{DN} \sim 0$ Hamamatsu VUV4

#### FBK VUV HD1 $f_{DN} \sim 0$ (FBK LF)

1) Dark Noise Rate is dominated by SRH Field enhanced contribution

2) Dark Noise Rate is **hole driven** in p-on-n SiPMs

3) Direct Cross Talk is hole driven in p-on-n SiPMs

4) After Pulse is hole driven in p-on-n SiPMs

![](_page_21_Figure_8.jpeg)

![](_page_21_Figure_10.jpeg)